

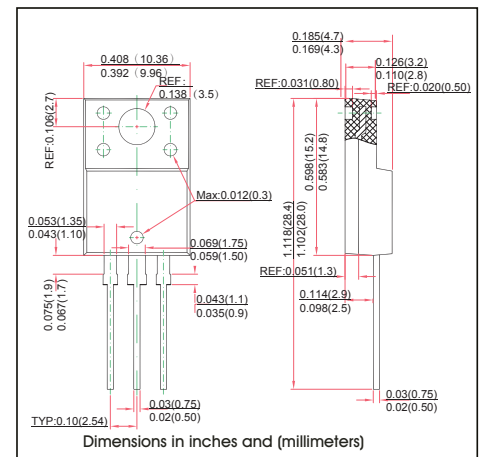
TO-220F Plastic-Encapsulate MOSFETS

FEATURE

- Excellent package for good heat dissipation
- Ultra low gate charge
- Low reverse transfer capacitance
- Fast switching capability
- Avalanche energy specified
- N-Channel Power MOSFET

MECHANICAL DATA

- Case style:TO-220F molded plastic
- Mounting position:any



MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	800	V
Gate-Source Voltage	V_{GS}	± 30	
Continuous Drain Current	I_D	3	A
Pulsed Drain Current	I_{DM}	10	
Single Pulsed Avalanche Energy (note1)	E_{AS}	170	mJ
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	62.5	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature Range	T_{STG}	-55 ~ +150	
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	T_L	260	

MOSFET ELECTRICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	8			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 800V, V_{GS} = 0V$	0		1	μA
Gate-body leakage current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 30V$			± 10	μA
On characteristics (note2)						
Gate-threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	3	3.7	4.5	V
Static drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 1.5A$		3.2	4.2	Ω
Forward transconductance	g_{fs}	$V_{DS} = 15V, I_D = 1.5A$		2.1		S
Dynamic characteristics (note 3)						
Input capacitance	C_{iss}	$V_{DS} = 25V, V_{GS} = 0V, f = 1MHz$		485		pF
Output capacitance	C_{oss}			57		
Reverse transfer capacitance	C_{riss}			11		
Switching characteristics (note 2,3)						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 400V, R_G = 4.7\Omega, I_D = 3A, V_{GS} = 10V$		17		ns
Turn-on rise time	t_r			27		
Turn-off delay time	$t_{d(off)}$			36		
Turn-off fall time	t_f			40		
Total Gate Charge	Q_g	$V_{DS} = 640V, V_{GS} = 10V, I_D = 3A$		19		nC
Gate-Source Charge	Q_{gs}			3.2		nC
Gate-Drain Charge	Q_{gd}			10.8		nC
Drain-Source Diode Characteristics						
Drain-source diode forward voltage	V_{SD}	$I_S = 0V, I_S = 3A$			1.6	V
Continuous drain-source diode forward current	I_S				3	A
Pulsed drain-source diode forward current	I_{SM}				10	A

Notes :

1. $I_L = 3A, V_{DD} = 50V, R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$.
2. Pulse Test : Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Guaranteed by design, not subject to production

RATINGS AND CHARACTERISTIC CURVES

